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**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Application of:

Jean KERSTEN

National Phase U.S. Application from  
International Application No.:  
PCT/EP99/05988

Filed: 12 August 1999

THERMOPLASTIC COMPOSITION

Docket No. 32396

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Examiner:

Assistant Commissioner of Patents  
Washington, D.C. 20231

Sir:

**INFORMATION DISCLOSURE STATEMENT**

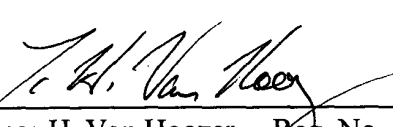
The attached references are being filed to fulfill the duty of candor and good faith toward  
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Respectfully submitted,

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INFORMATION DISCLOSURE STATEMENT BY APPLICANT  (Use several sheets if necessary)		APPLICANT: Jean KERSTEN, Carole LAMANT, Jean-Francois SNAPS	
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## U.S. PATENT DOCUMENTS

EXAM. INITIAL	DOCUMENT NUMBER								DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
	4	6	0	7	0	7	4	8/19/1986	Hazelton et al.				

## FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER								DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION		
														YES	NO	
	WO	9	6	1	8	6	7	8	6/20/1996	PCT						
	WO	8	7	0	5	3	1	0	9/11/1987	PCT						

## OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)


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